507700784 01/18/2023

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
PETER GAZZERRO	01/03/2023
NITZ SAPUTRA	01/15/2023
ASHOK SWAMINATHAN	01/06/2023
OSAMA ELHADIDY	01/03/2023
BO YANG	01/17/2023

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	18068837

CORRESPONDENCE DATA

Fax Number: (713)623-4846

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 7136234844

Email: dcarlson@pattersonsheridan.com,

psdocketing@pattersonsheridan.com

Correspondent Name: PATTERSON + SHERIDAN, LLC

Address Line 1: 24 GREENWAY PLAZA

Address Line 2: SUITE 1600

Address Line 4: HOUSTON, TEXAS 77046

ATTORNEY DOCKET NUMBER:	QUAL/2203245US
NAME OF SUBMITTER:	DANIELLE S. CARLSON
SIGNATURE:	/Danielle S. CARLSON/
DATE SIGNED:	01/18/2023

Total Attachments: 7

PATENT REEL: 062409 FRAME: 0687

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ASSIGNMENT

WHEREAS, WE,

- 1. Peter GAZZERRO, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 2. Nitz SAPUTRA, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 3. Ashok SWAMINATHAN, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 4. Osama ELHADIDY, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A.,
- 5. Bo YANG, having a mailing address located at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S. A..

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to WIDEBAND CURRENT-MODE LOW-PASS FILTER CIRCUITS (collectively the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated (hereinafter "ASSIGNEE"), a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A., desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to **U.S. Application No(s).** 18/068,837 filed **December 20, 2022**, **Qualcomm Reference Number 2203245**, and all provisional applications relating thereto (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number (s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States;

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent

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applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States or in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to me respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries;

AND WE HEREBY coveriant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

60.00	San Diego, CA, United States	01/03/2023	19 ja 24
Done at			
	City, State, Country	Date	Peter GAZZERRO

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Burlingame, CA, United States on	01/15/2023	二马太
	City, State, Country	Date	Nitz SAPUTRA

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at Cardiff, CA, United States 01/06/2023

City, State, Country Date Ashok SWAMINATHAN

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

	Sun Diego, CA, United States	01/03/2023	Dry Mula	
Dome m				atilije.
	City, State, Country	Date	Osama ELHADIDY	ŝ

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AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at ______on ____on ___

01/17/2023

City, State, Country

Date / W/A

PATENT REEL: 062409 FRAME: 0695

RECORDED: 01/18/2023